



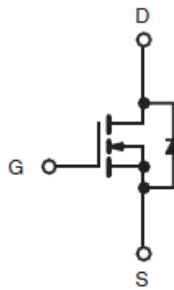
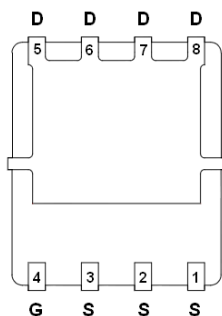
General Description

AFN6448S, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge. These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial surface mount applications.

Features

- 80V/10A, $R_{DS(ON)} = 9.8m\Omega @ V_{GS} = 10V$
- 80V/ 8A, $R_{DS(ON)} = 11.8m\Omega @ V_{GS} = 6V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- DFN5X6-8L package design

Pin Description (DFN5X6-8L)



Application

- Synchronous Rectifier
- Power Supplies
- LED TV

Pin Define

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFN6448SFN568RG	6448S	DFN5X6-8L	Tape & Reel	2500 EA

- ※ 6448S : Parts Code
- ※ YYMMDD : Date Code
- ※ AFN6448SFN568RG : 13" Tape & Reel ; Pb- Free ; Halogen- Free



Absolute Maximum Ratings

(T_A=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	80	V
Gate –Source Voltage	V _{GSS}	±20	V
Continuous Drain Current(T _J =150°C)	I _{DSM}	T _A =25°C	11
		T _A =70°C	9
Pulsed Drain Current	I _{DM}	50	A
Continuous Source Current(Diode Conduction)	I _S	4.7	
Single Pulse Avalanche Current	I _{AS}	50	
Power Dissipation	P _{DSM}	T _A =25°C	2.5
		T _A =75°C	1.6
Operating Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	t ≤ 10 s	15
		Steady-State	45

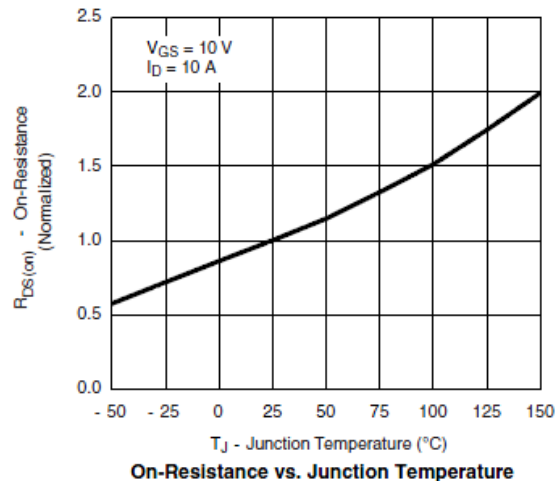
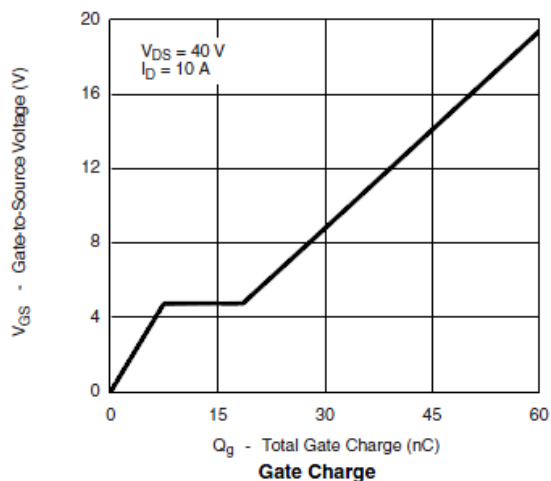
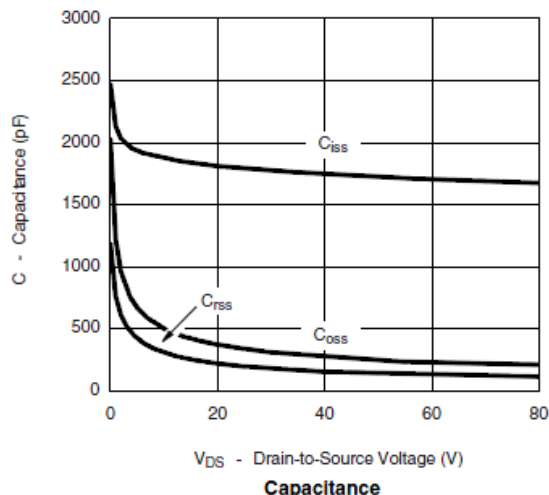
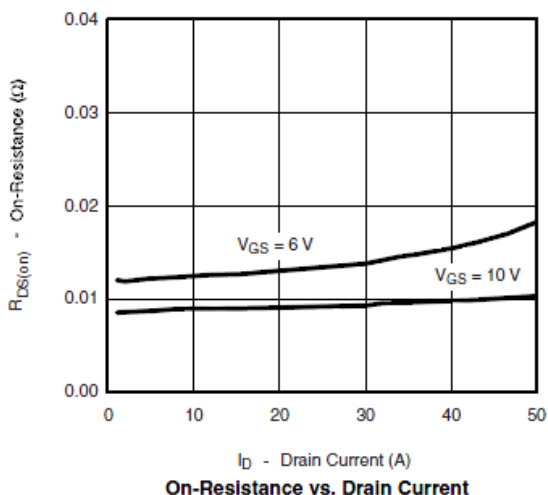
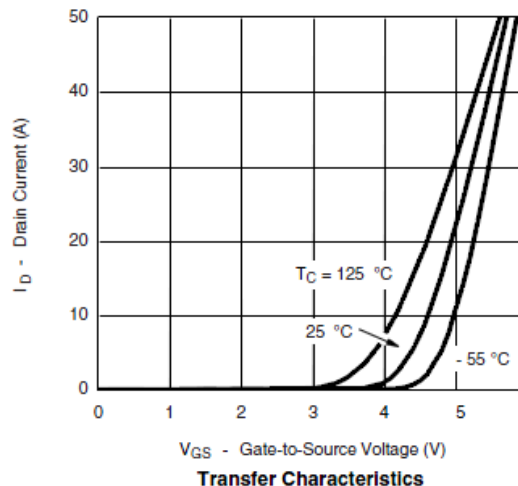
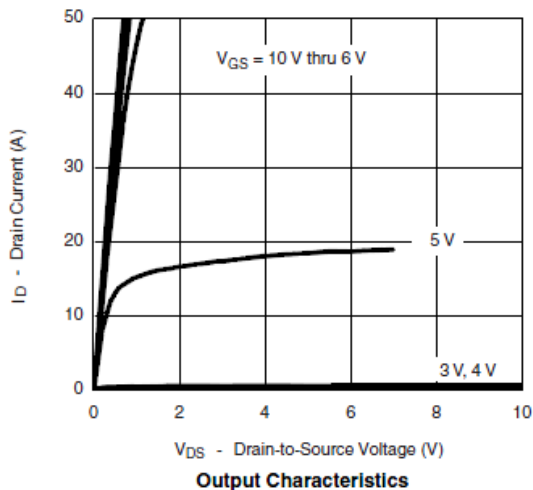
Electrical Characteristics

(T_A=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250uA	80			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	2.0		4.0	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =64V, V _{GS} =0V			1	uA
		V _{DS} =64V, V _{GS} =0V T _J =85°C			30	
On-State Drain Current	I _{D(on)}	V _{DS} ≥ 5V, V _{GS} =10V	50			A
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =10A		8.3	9.8	mΩ
		V _{GS} =6V, I _D =8A		9.6	11.8	
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =10A		30		S
Diode Forward Voltage	V _{SD}	I _S =1A, V _{GS} =0V		0.8	1.3	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =40V, V _{GS} =10V I _D ≡10A		35	55	nC
Gate-Source Charge	Q _{gs}			8		
Gate-Drain Charge	Q _{gd}			12		
Input Capacitance	C _{iss}	V _{DS} =40V, V _{GS} =0V f=1MHz		2800		pF
Output Capacitance	C _{oss}			360		
Reverse Transfer Capacitance	C _{rss}			150		
Turn-On Time	t _{d(on)}	V _{DD} =40V, R _L =40Ω I _D ≡10A, V _{GEN} =10V R _G =6Ω		18	35	ns
	t _r			12	25	
Turn-Off Time	t _{d(off)}			40	80	
	t _f			32	65	

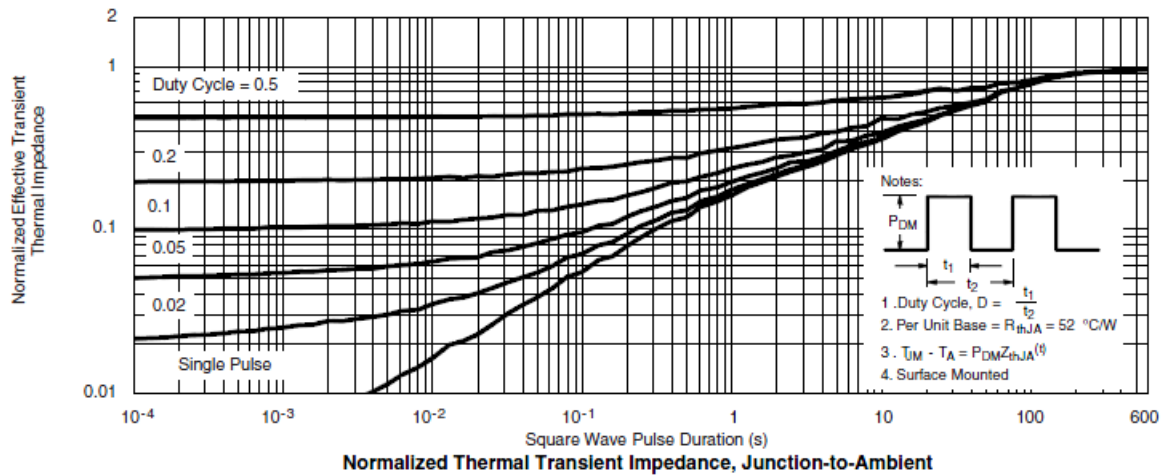
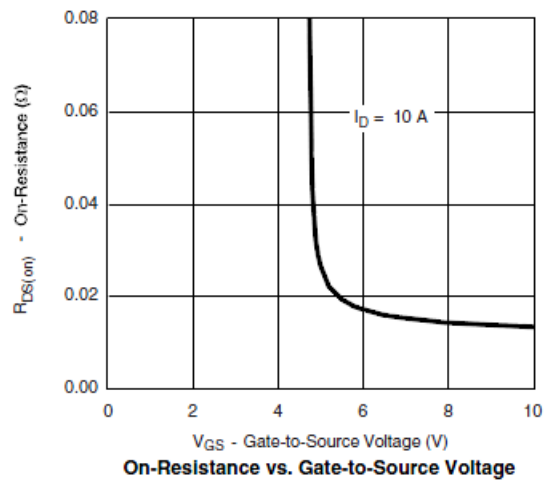
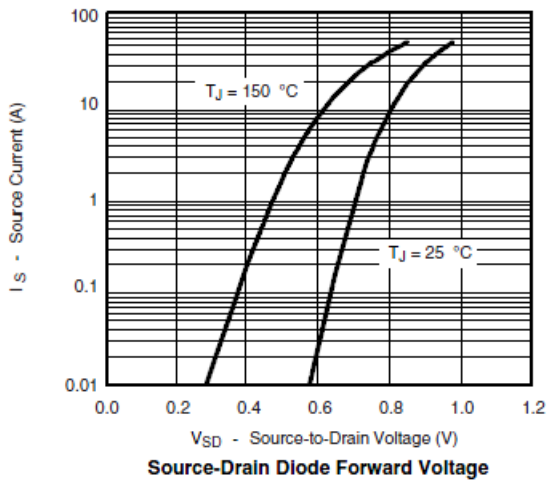
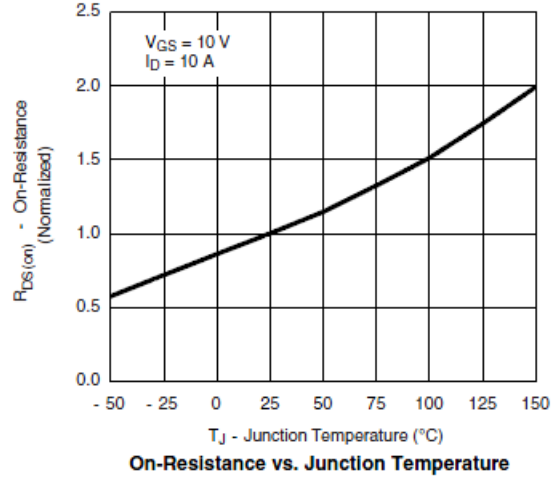
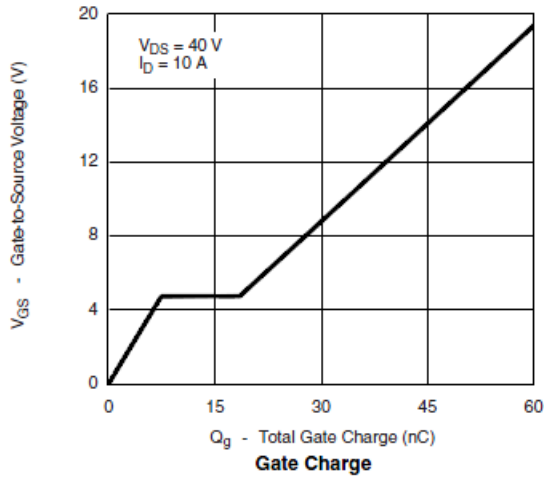


Typical Characteristics





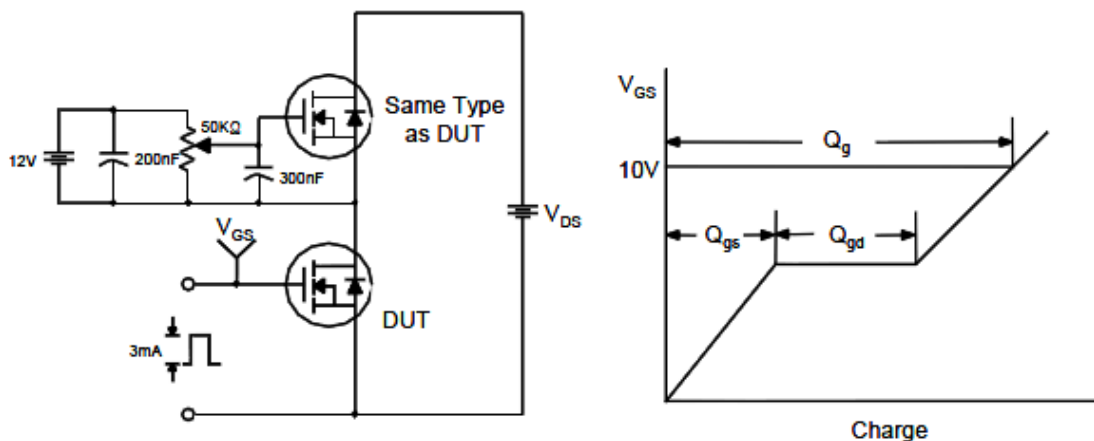
Typical Characteristics



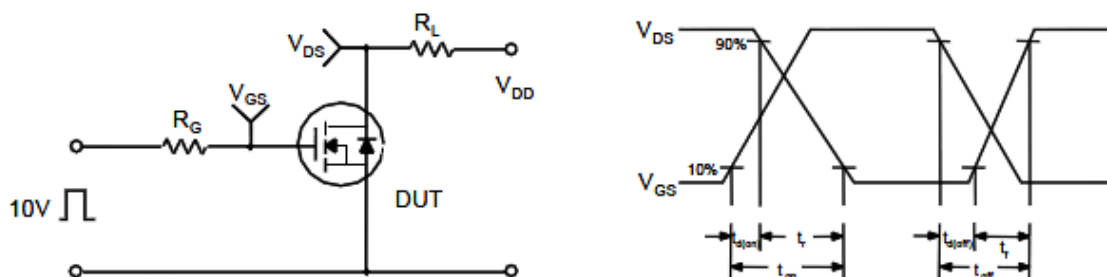


Typical Characteristics

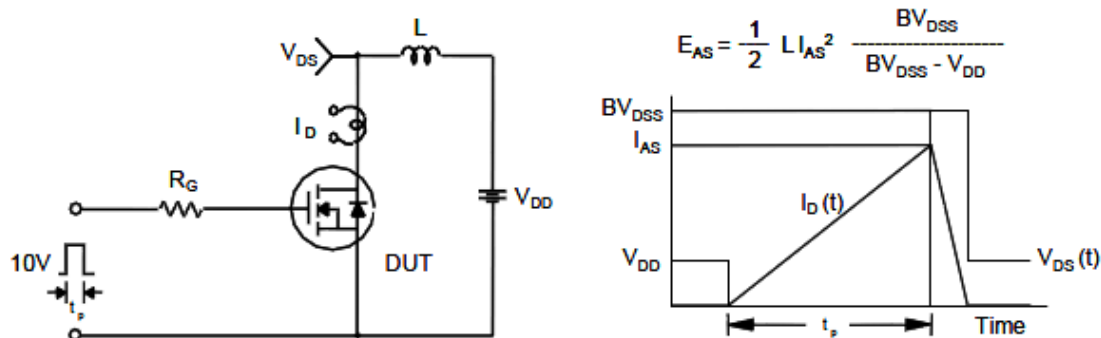
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

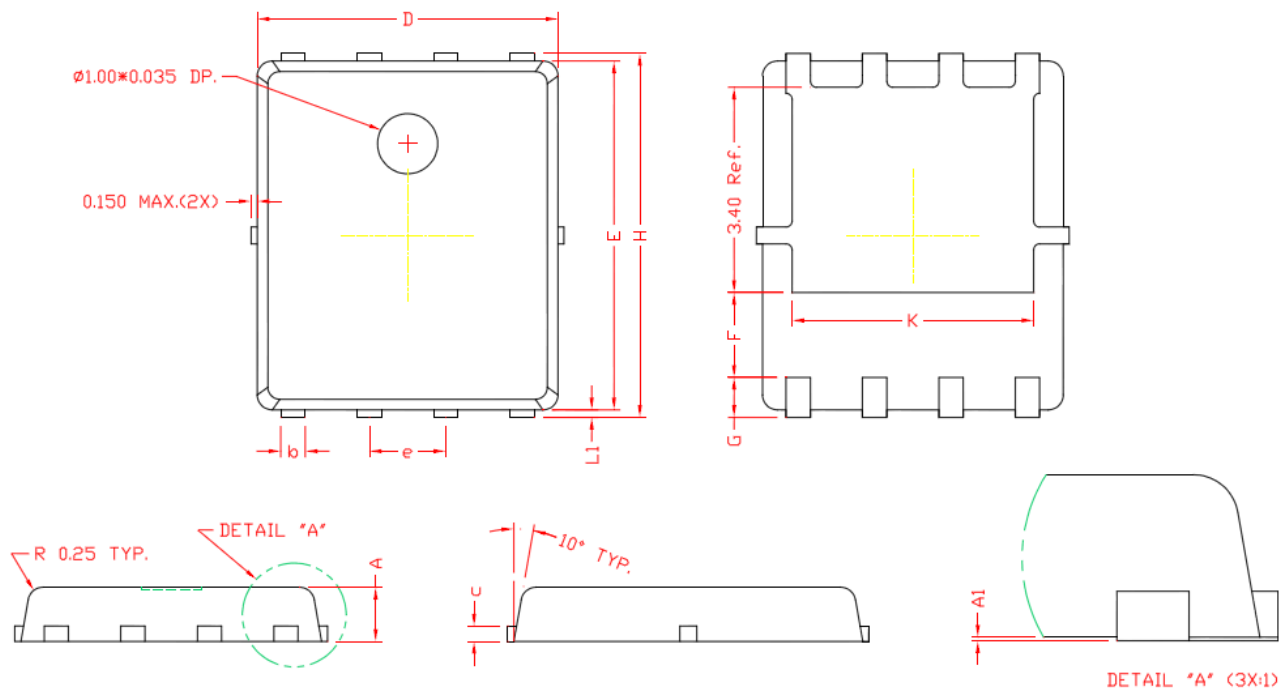


Unclamped Inductive Switching Test Circuit & Waveforms





Package Information (DFN5X6-8L)



DIMENSIONS

REF.	Millimeters		REF.	Millimeters	
	Min.	Max.		Min.	Max.
A	0.80	1.00	E	5.70	5.90
A1	0.00	0.05	e	1.27 BSC.	
b	0.35	0.49	H	5.95	6.20
c	0.254 Ref.		L1	0.10	0.18
D	4.90	5.10	G	0.60 Ref.	
F	1.40 Ref.		K	4.00 Ref.	

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